

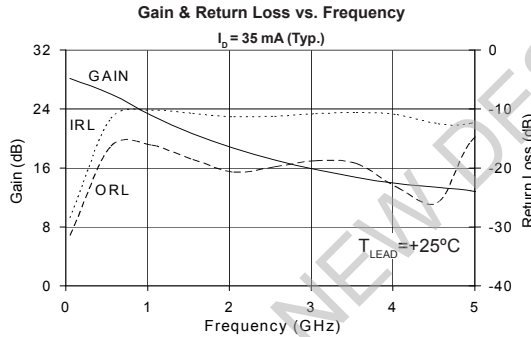


### Product Description

The SGA3586Z is a high performance SiGe HBT MMIC Amplifier. A Darlington configuration featuring one-micron emitters provides high  $F_T$  and excellent thermal performance. The heterojunction increases breakdown voltage and minimizes leakage current between junctions. Cancellation of emitter junction non-linearities results in higher suppression of intermodulation products. Only two DC-blocking capacitors, a bias resistor, and an optional RF choke are required for operation.

#### Optimum Technology Matching® Applied

- GaAs HBT
- GaAs MESFET
- InGaP HBT
- SiGe BiCMOS
- Si BiCMOS
- SiGe HBT
- GaAs pHEMT
- Si CMOS
- Si BJT
- GaN HEMT
- RF MEMS



### Features

- High Gain: 25dB at 850MHz
- Cascadable 50Ω Gain Block
- High Output  $IP_3$ : 25dBm typ. at 1950MHz
- Low Noise Figure: 2.5dB typ. at 1950MHz
- Low Current Draw: 35mA typ.
- Single Voltage Supply Operation

### Applications

- PA Driver Amplifier
- Cellular, PCS, GSM, UMTS
- IF Amplifier
- Wireless Data, Satellite

Parameter	Specification			Unit	Condition
	Min.	Typ.	Max.		
Small Signal Gain	22.5	25.0	27.5	dB	850MHz
	18.0	20.0	22.0		1950MHz
Output Power at 1dB Compression	11.0	12.5	13.0	dBm	850MHz
	23.0	25.0	24.5		1950MHz
Output Third Intercept Point		25.0		dBm	1950MHz
Bandwidth Determined by Return Loss		5000		MHz	>10dB
Input Return Loss	9.5	11.0		dB	1950MHz
Output Return Loss	14.0	20.0		dB	1950MHz
Noise Figure		2.5	3.5	dB	1950MHz
Device Operating Voltage	3.0	3.25	3.5	V	
Device Operating Current	31	35	39	mA	
Thermal Resistance (Junction - Lead)		97		°C/W	

Test Conditions:  $I_b = 35 \text{ mA Typ.}$ ,  $T_{LEAD} = 25^\circ\text{C}$ ,  $Z_S = Z_L = 50\Omega$ ,  $P_{OUT}$  per tone = -5dBm,  $OIP_3$  Tone Spacing = 1MHz

## Absolute Maximum Ratings

Parameter	Rating	Unit
Max Device Current ( $I_D$ )	70	mA
Max Device Voltage ( $V_D$ )	6	V
Max RF Input Power	+18	dBm
Max Junction Temp ( $T_J$ )	+150	°C
Operating Temp Range ( $T_L$ )	-55 to +110	°C
Max Storage Temp	+150	°C

Operation of this device beyond any one of these limits may cause permanent damage. For reliable continuous operation, the device voltage and current must not exceed the maximum operating values specified in the table on page one.

Bias Conditions should also satisfy the following expression:

$$I_D V_D < (T_J - T_L) / R_{TH, J-H}$$



**Caution!** ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

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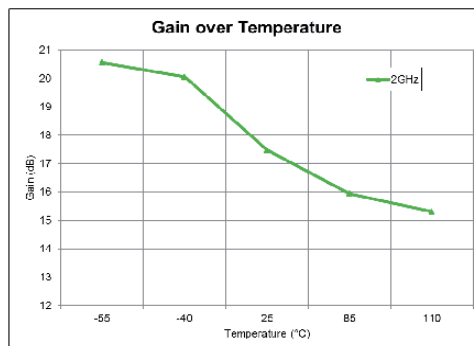
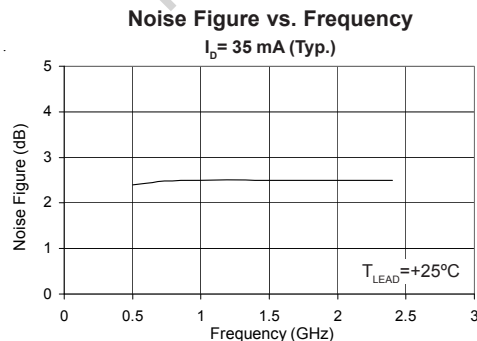
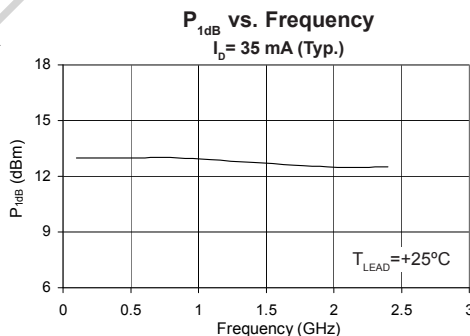
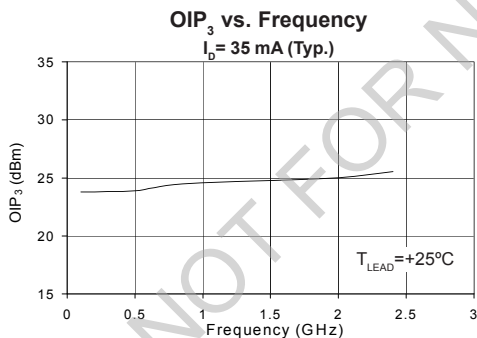


65/EURFMD Green: RoHS compliant per EU Directive 2011/65/EU, halogen free per IEC 61249-2-21, < 1000ppm each of antimony trioxide in polymeric materials and red phosphorus as a flame retardant, and <2% antimony in solder.

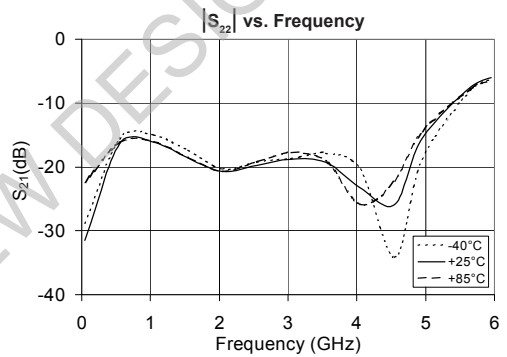
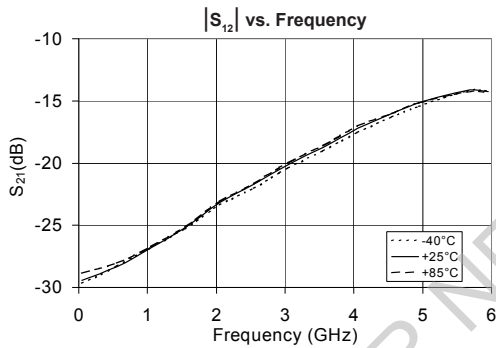
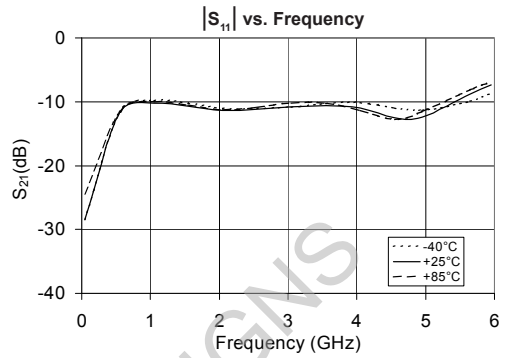
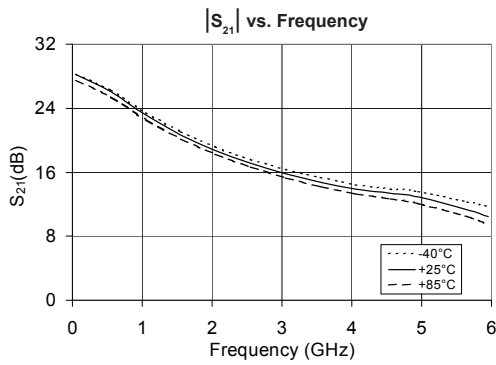
## Typical Performance at Key Operating Frequencies

Parameter	Unit	100 MHz	500 MHz	850 MHz	1950 MHz	2400 MHz	3500 MHz
Small Signal Gain	dB	28.2	27.1	25.0	19.7	18.3	14.8
Output Third Order Intercept Point	dBm	23.8	23.9	24.5	25.0	25.5	
Output Power at 1dB Compression	dBm	13.0	13.0	13.0	12.5	12.5	
Input Return Loss	dB	28.4	12.8	10.7	10.5	11.1	10.6
Output Return Loss	dB	31.5	17.1	15.9	20.5	20.3	18.9
Reverse Isolation	dB	29.4	29.0	28.1	24.1	22.4	19.2
Noise Figure	dB		2.4	2.5	2.5	2.5	

Test Conditions:  $I_D = 35$  mA Typ.,  $OIP_3$  Tone Spacing = 1 MHz,  $P_{OUT}$  per tone = -5 dBm,  $R_{BIAS} = 100 \Omega$ ,  $T_L = 25^\circ C$ ,  $Z_S = Z_L = 50 \Omega$



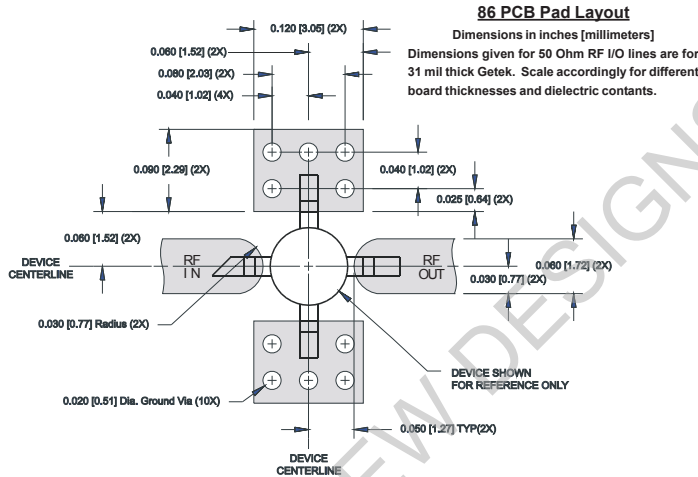
Typical RF Performance Over Lead Temperature -- Bias:  $I_b = 35$  mA (Typ.) at  $T_{LEAD} = +25^\circ\text{C}$



NOT FOR NEW DESIGNS

Pin	Function	Description
1	RF IN	RF input pin. This pin requires the use of an external DC-blocking capacitor chosen for the frequency of operation.
2, 4	GND	Connection to ground. For optimum RF performance, use via holes as close to ground leads as possible to reduce lead inductance.
3	RF OUT/BIAS	RF output and bias pin. DC voltage is present on this pin, therefore a DC-blocking capacitor is necessary for proper operation.

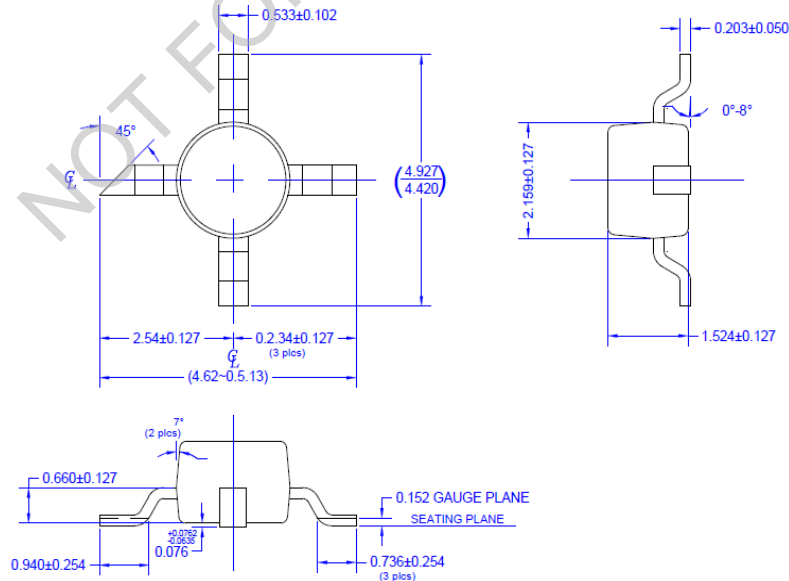
## Suggested Pad Layout



## Package Drawing

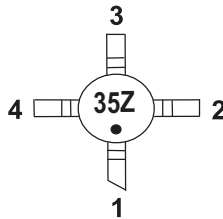
Dimensions in millimeters

Refer to drawing posted at [www.rfmd.com](http://www.rfmd.com) for tolerances.





## Part Identification



## Ordering Information

Ordering Code	Description
SGA3586Z	13" Reel with 3000 pieces
SGA3586ZSQ	Sample bag with 25 pieces
SGA3586ZSR	7" Reel with 100 pieces
SGA3586ZPCK1	850MHz, 5V Operation PCBA with 5-piece sample bag

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